

TPS3813J25, TPS3813L30 TPS3813K33, TPS3813I50

SLVS331G - DECEMBER 2000 - REVISED OCTOBER 2013

Processor Supervisory Circuits with Window-Watchdog

Check for Samples: TPS3813J25, TPS3813L30, TPS3813K33, TPS3813I50

FEATURES

- Window-Watchdog With Programmable Delay and Window Ratio
- 6-Pin SOT-23 Package
- Supply Current of 9 µA (Typ)
- Power On Reset Generator With a Fixed Delay Time of 25 ms
- Precision Supply Voltage Monitor 2.5 V, 3 V, 3.3 V, 5 V
- Open-Drain Reset Output
- Temperature Range -40°C to +85°C

APPLICATIONS

- Applications Using DSPs, Microcontrollers, or Microprocessors
- Safety Critical Systems
- Automotive Systems
- Heating Systems

DESCRIPTION

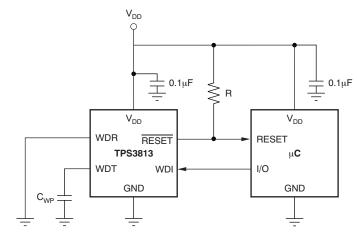
The TPS3813 family of supervisory circuits provide circuit initialization and timing supervision, primarily for DSPs and processor-based systems.

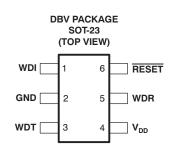
During power on, RESET is asserted when supply voltage (V_{DD}) becomes higher than 1.1 V. Thereafter, the supervisory circuit monitors V_{DD} and keeps RESET active as long as V_{DD} remains below the threshold voltage (V_{IT}). An internal timer delays the return of the output to the inactive state (high) to ensure proper system reset. The delay time, $t_d = 25$ ms typical, starts after V_{DD} has risen above the threshold voltage (V_{IT}). When the supply voltage drops below the threshold voltage (V_{IT}). When the supply voltage drops below the threshold voltage (V_{IT}), the output becomes active (low) again. No external components are required. All the devices of this family have a fixed-sense threshold voltage (V_{IT}) set by an internal voltage divider.

For safety critical applications the TPS3813 family incorporates a so-called window-watchdog with programmable delay and window ratio. The upper limit of the watchdog time-out can be set by either connecting WDT to GND, V_{DD} , or using an external capacitor. The lower limit and thus the window ratio is set by connecting WDR to GND or V_{DD} . The supervised processor now needs to trigger the TPS3813 within this window not to assert a RESET.

The product spectrum is designed for supply voltages of 2.5 V, 3 V, 3.3 V, and 5 V. The circuits are available in a 6-pin SOT-23 package.

The TPS3813 devices are characterized for operation over a temperature range of -40° C to 85° C.





Typical Operating Circuit

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This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

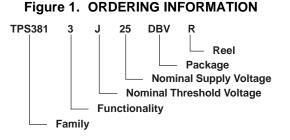
ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

PACKAGE AND ORDERING INFORMATION

T _A	DEVICE NAME	THRESHOLD VOLTAGE	MARKING			
	TPS3813J25DBV	2.25 V	PCDI			
40%0 to +05%0	TPS3813L30DBV	2.64 V	PEZI			
–40°C to +85°C	TPS3813K33DBV	2.93 V	PFAI			
	TPS3813I50DBV	4.55 V	PFBI			

PACKAGE INFORMATION⁽¹⁾

(1) For the most current package and ordering information see the Package Option Addendum at the end of this document, or see the device product folder at www.ti.com.



ABSOLUTE MAXIMUM RATINGS

Over operating free-air temperature range (unless otherwise noted).⁽¹⁾

		UNIT
	Supply voltage ⁽²⁾	7 V
V_{DD}	RESET	–0.3 V to V _{DD} + 0.3 V
	All other pins ⁽²⁾	–0.3 V to 7 V
I _{OL}	Maximum low output current	5 mA
I _{OH}	Maximum high output current	–5 mA
l _{IK}	Input clamp current (V _I < 0 or V _I > V _{DD})	±20 mA
I _{OK}	Output clamp current ($V_O < 0$ or $V_O > V_{DD}$)	±20 mA
	Continuous total power dissipation	See Dissipation Rating Table
T _A	Operating free-air temperature range	–40°C to +85°C
T _{stg}	Storage temperature range	–65°C to +150°C
	Soldering temperature	+260°C

(1) Stresses beyond those listed under absolute maximum ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under recommended operating conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) All voltage values are with respect to GND. For reliable operation the device should not be operated at 7 V for more than t = 1000h continuously.

DISSIPATION RATING TABLE

PACKAGE	T _A < +25°C	DERATING FACTOR	T _A = +70°C	T _A = +85°C
	POWER RATING	ABOVE T _A = +25°C	POWER RATING	POWER RATING
DBV	437 mW	3.5 mW/°C	280 mW	227 mW

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RECOMMENDED OPERATING CONDITIONS

At spec	ified temperature range.			
		MIN	MAX	UNIT
V_{DD}	Supply voltage	2	6	V
VI	Input voltage	0	$V_{DD} + 0.3$	V
VIH	High-level input voltage	$0.7 \times V_{DD}$		V
V _{IL}	Low-level input voltage		$0.3 \times V_{DD}$	V
$\Delta t / \Delta V$	Input transition rise and fall rate		100	ns/V
t _w	Pulse width of WDI trigger pulse	50		ns
T _A	Operating free-air temperature range	-40	+85	°C

ELECTRICAL CHARACTERISTICS

Over recommended operating free-air temperature range (unless otherwise noted).

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT	
			$V_{DD} = 2 \text{ V to } 6 \text{ V}, I_{OL} = 500 \mu\text{A}$			0.2	
V_{OL}	Low-level output voltage		$V_{DD} = 3.3 \text{ V I}_{OL} = 2 \text{ mA}$			0.4	V
			$V_{DD} = 6 V$, $I_{OL} = 4 mA$			0.4	
	Power up reset voltage ⁽¹⁾		$V_{DD} \ge 1.1 \text{ V}, I_{OL} = 50 \ \mu\text{A}$			0.2	V
		TPS3813J25		2.2	2.25	2.3	
V	Negative-going input threshold	ative-going input threshold TPS3813L30 ge $^{(2)}$ TPS3813K33 $T_A = -40^{\circ}C$ to +85°C	2.58	2.64	2.7	V	
V _{IT}	voltage ⁽²⁾		2.87	2.93	3		
		TPS3813I50		4.45	4.55	4.65	
		TPS3813J25			30		
	l hustone sis	TPS3813L30			35		
V _{hys}	Hysteresis	TPS3813K33			40		mV
		TPS3813I50			60		
		WDI, WDR	$WDI = V_{DD} = 6 V, WDR = V_{DD} = 6 V$	-25		25	
IIH	High-level input current	WDT	WDT = V_{DD} = 6 V, V_{DD} > V_{IT} , \overline{RESET} = High	-100		100	- 1
	I and the set former of	WDI, WDR	WDI = 0 V, WDR = 0 V, V _{DD} = 6 V	-25		25	nA
I _{IL} Low-level input current		WDT	WDT = 0 V, $V_{DD} > V_{IT}$, RESET = High	-100		100	
I _{OH} High-level output current		$V_{DD} = V_{IT} + 0.2 \text{ V}, V_{OH} = V_{DD}$			25	nA	
	Current aurorat		V _{DD} = 2 V output unconnected		9	13	
I _{DD}	Supply current		V _{DD} = 5 V output unconnected		20	25	μA
Ci	Input capacitance		$V_{I} = 0 V \text{ to } V_{DD}$		5		pF

(1)

The lowest supply voltage at which $\overline{\text{RESET}}$ becomes active. t_r, $V_{DD} \ge 15 \ \mu\text{s/V}$. To ensure best stability of the threshold voltage, a bypass capacitor (ceramic, 0.1 μ F) should be placed near to the supply terminals. (2)



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TIMING REQUIREMENTS

At $R_L = 1 \text{ M}\Omega$, $C_L = 50 \text{ pF}$, and $T_A = -40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$.

	PARAMETER	TEST CONDITIONS	MIN	TYP MAX	UNIT
tw	Pulse width at V_{DD}	$V_{DD} = V_{IT-} + 0.2 \text{ V}, V_{DD} = V_{IT-} - 0.2 \text{ V}$	3		μs

SWITCHING CHARACTERISTICS

At $R_L = 1 \text{ M}\Omega$, $C_L = 50 \text{ pF}$, and $T_A = -40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$.

	PARAMETE	R	TEST CONDITIONS	MIN	TYP	MAX	UNIT
t _d	t _d Delay time		$V_{DD} \ge V_{IT} + 0.2 V$, See timing diagram	20	25	30	ms
			WDT = 0 V	0.2 0.25		0.3	
t _{t(out)}	Watchdog time-out	Upper limit	$WDT = V_{DD}$	2	2.5	3	S
			WDT = programmable ⁽¹⁾		See (2)		ms
			WDR = 0 V, WDT = 0 V		1:31.8		
			$WDR = 0 V, WDT = V_{DD}$		1:32		
	Wetch do a window actio		WDR = 0 V, WDT = programmable		1:25.8		
	Watchdog window ratio		$WDR = V_{DD}, WDT = 0 V$		1:124.9		
			$WDR = V_{DD}, WDT = V_{DD}$		1:127.7		
			WDR = V_{DD} , WDT = programmable		1:64.5		
t _{PHL}	Propagation (delay) time, high-to-low-level output	V_{DD} to RESET delay	$V_{IL} = V_{IT} - 0.2 \text{ V}, V_{IH} = V_{IT} + 0.2 \text{ V}$		30	50	μs

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 $\begin{array}{ll} (1) & 155 \ \text{pF} < C_{(ext)} < 63 \ \text{nF} \\ (2) & (C_{(ext)} \div 15.55 \ \text{pF} + 1) \times 6.25 \ \text{ms} \end{array}$

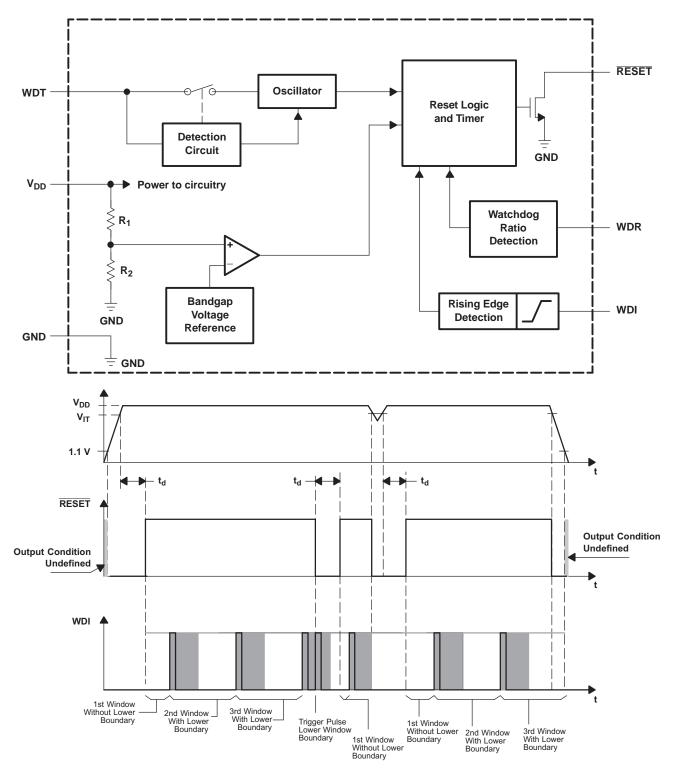
Table 1. TPS3813 FUNCTION/TRUTH TABLE

V _{DD} > V _{IT}	RESET
0	L
1	Н

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The lower boundary of the watchdog window starts with the rising edge of the WDI trigger pulse. At the same time, all internal timers will be reset. If an external capacitor is used, the lower boundary is impacted due to the different oscillator frequency. This is described in more detail in the following section. The timing diagram and especially the shaded boundary is prepared in a nonreal ratio scale to better visualize the description.

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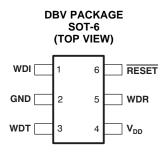
Product Folder Links: TPS3813J25 TPS3813L30 TPS3813K33 TPS3813I50

TEXAS INSTRUMENTS

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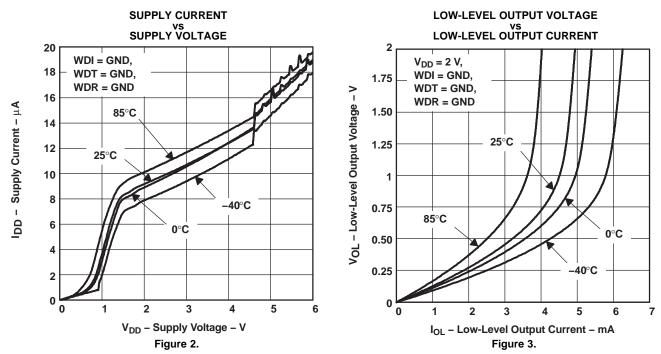
PIN CONFIGURATIONS



Terminal Functions

TERMINAL						
NAME	NO.	I/O	DESCRIPTION			
GND	2	I	round			
RESET	6	0	pen-drain reset output			
V _{DD}	4	I	Supply voltage and supervising input			
WDI	1	I	/atchdog timer input. This input must be driven at all times and not left floating.			
WDR	5	I	electable watchdog window ratio input. This input must be tied to V _{DD} or GND and not left floating.			
WDT	3	I	rogrammable watchdog delay input			

TYPICAL CHARACTERISTICS

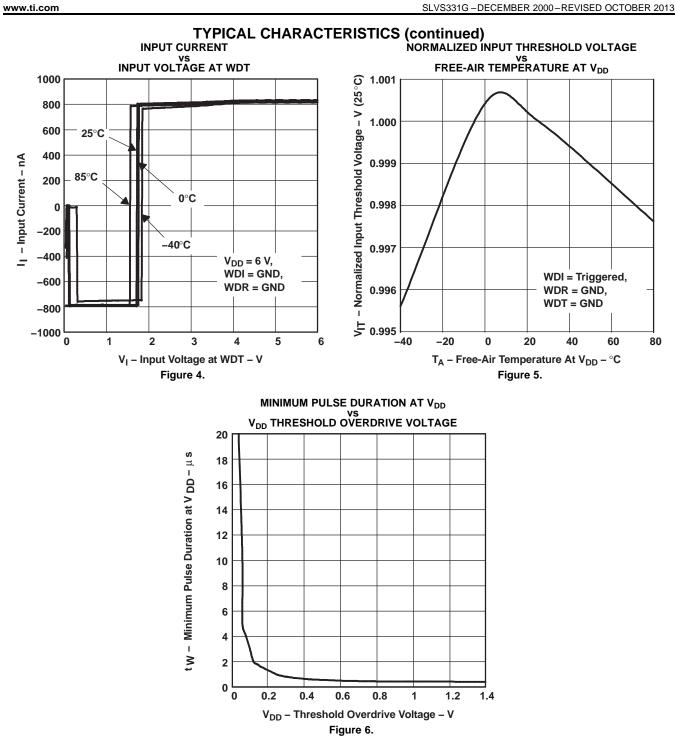


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DETAILED DESCRIPTION

IMPLEMENTED WINDOW-WATCHDOG SETTINGS

There are two different ways to set up the watchdog window. The first way is to use the implemented timing which is a default setting. Or, the default settings can be activated by wiring the WDT and WDR pin to V_{DD} or GND. There is a total of four different timings available with these settings. They are listed in the table below.

SELECTED C	SELECTED OPERATION MODE		LOWER WINDOW FRAME
		Max = 0.3 s	Max = 9.46 ms
	WDR = 0 V	Typ = 0.25 s	Typ = 7.86 ms
WDT = 0 V		Min = 0.2 s	Min = 6.27 ms
		Max = 0.3 s	Max = 2.43 ms
	$WDR = V_{DD}$	Typ = 0.25 s	Typ = 2 ms
		Min = 0.2 s	Min = 1.58 ms
		Max = 3 s	Max = 93.8 ms
	WDR = 0 V	Typ = 2.5 s	Typ = 78.2 ms
		Min = 2 s	Min = 62.5 ms
$WDT = V_{DD}$		Max = 3 s	Max = 23.5 ms
	$WDR = V_{DD}$	Typ = 2.5 s	Typ = 19.6 ms
		Min = 2 s	Min = 15.6 ms

To visualize the values named in the table, a timing diagram was prepared. It is used to describe the upper and lower boundary settings. For an application, the important boundaries are the $t_{boundary,max}$ and $t_{window,min}$. Within these values, the watchdog timer should be retriggered to avoid a timeout condition or a boundary violation in the event of a trigger pulse in the lower boundary. The values in the table above are typical and worst case conditions. They are valid over the whole temperature range of -40° C to $+85^{\circ}$ C.

In the shaded area of Figure 7, it cannot be predicted if the device will detect a violation or not and release a reset. This is also the case between the boundary tolerance of $t_{boundary,min}$ and $t_{boundary,max}$ as well as between $t_{window,min}$ and $t_{window,max}$. It is important to set up the trigger pulses accordingly to avoid violations in these areas.

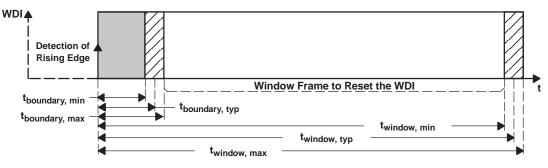


Figure 7. Upper and Lower Boundary Visualization

TIMING RULES OF WINDOW-WATCHDOG

After the reset of the supervisor is released, the lower boundary of the first WDI window is disabled. However, after the first WDI pulse low-to-high transition is detected, the lower boundary function of the window is enabled. All further WDI pulses will need to fit into the configured window frame.

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PROGRAMMABLE WINDOW-WATCHDOG BY USING AN EXTERNAL CAPACITOR

The upper boundary of the watchdog timer can be set by an external capacitor connected between the WDT pin and GND. Common consumer electronic capacitors can be used to implement this feature. They should have low ESR and low tolerances since the tolerances have to be considered if the calculations are performed. The first formula is used to calculate the upper window frame. After calculating the upper window frame, the lower boundary can be calculated. As in the last example, the most important values are the t_{boundary,max} and t_{window,min}. The trigger pulse has to fit into this window frame.

The external capacitor should have a value between a minimum of 155 pF and a maximum of 63 nF.

SELECTED OPER	ATION MODE	WINDOW FRAME
WDT = external capacitor $C_{(ext)}$	WDR = 0 V and WDR = V_{DD}	$t_{window,max} = 1.25 \times t_{window,typ}$ $t_{window,min} = 0.75 \times t_{window,typ}$
$t_{window,typ} = \left(\frac{C_{(ext)}}{15.55 \text{ pF}} + 1\right)$	× 6.25 ms	(1)

LOWER BOUNDARY CALCULATION

The lower boundary can be calculated based on the values given in the switching characteristics. Additionally, facts have to be taken into account to verify that the lower boundary is where it is expected. Since the internal oscillator of the window watchdog is running free, any rising edge at the WDI pin will be taken into account at the next internal clock cycle. This happens regardless of the external source. Since the shift between internal and external clock is not known, it is best to consider the worst case condition for calculating this value.

SELECTED OPERATION	MODE	LOWER BOUNDARY OF FRAME
	WDR = 0 V	t _{boundary,max} = t _{window,max} / 23.5 t _{boundary,typ} = t _{window,typ} / 25.8 t _{boundary,min} = t _{window,min} / 28.7
WDT = external capacitor C _(ext)	WDR = V _{DD}	t _{boundary,max} = t _{window,max} / 51.6 t _{boundary,typ} = t _{window,typ} / 64.5 t _{boundary,min} = t _{window,min} / 92.7

WATCHDOG SOFTWARE CONSIDERATIONS

To benefit from the window watchdog feature and help the watchdog timer monitor the software execution more closely, it is recommended that the watchdog be set and reset at different points in the program rather than pulsing the watchdog input periodically by using the prescaler of a microcontroller or DSP. Furthermore, the watchdog trigger pulses should be set to different timings inside the window frame to release a defined reset, if the program should hang in any subroutine. This allows the window watchdog to detect timeouts of the trigger pulse as well as pulses that distort the lower boundary.

POWER-UP CONSIDERATIONS

Many microcontrollers use general-purpose input/output (GPIO) pins that can be programmed to be either inputs or outputs. During power-up, these I/O pins are typically configured as inputs. If a GPIO pin is used to drive the WDI input pin of the TPS3813, then a pull-down resistor (shown as **R2** in Figure 8) should be added to keep the WDI pin from floating during power-up.

In applications where the WDI input may experience a negative voltage while V_{DD} is ramping between 0 V and 0.8 V, then the V_{DD} slew rate in this range should be greater than 10 V/s. A negative voltage on the WDI input along with a slew rate less than 10 V/s could result in a greatly reduced watchdog window time and reset output delay time.

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APPLICATION EXAMPLE

A typical application example (see Figure 8) is used to describe the function of the watchdog in more detail.

To configure the window watchdog function, two pins are provided by the TPS3813. These pins set the window timeout and ratio.

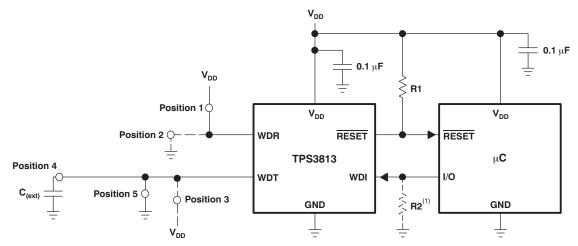
The window watchdog ratio is a fixed ratio, which determines the lower boundary of the window frame. It can be configured in two different frame sizes.

If the window watchdog ratio pin (WDR) is set to V_{DD} , Position 1 in Figure 8, then the lower window frame is a value based on a ratio calculation of the overall window timeout size: For the watchdog timeout pin (WDT) connected to GND, it is a ratio of 1:124.9, for WDT connected to V_{DD} , it is a ratio of 1:127.7, and for an external capacitor connected to WDT, it is a ratio of 1:64.5.

If the window watchdog ratio pin (WDR) is set to GND, Position 2, the lower window frame will be a value based on a ratio calculation of the overall window timeout size: For the watchdog timeout pin (WDT) connected to GND, it will be a ratio of 1:31.8, for WDT connected to V_{DD} it will be 1:32, and for an external capacitor connected to WDT it will be 1:25.8.

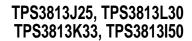
The watchdog timeout can be set in two fixed timings of 0.25 seconds and 2.5 seconds for the window or can by programmed by connecting a external capacitor with a low leakage current at WDT.

Example: If the watchdog timeout pin (WDT) is connected to V_{DD} , the timeout will be 2.5 seconds. If the window watchdog ratio pin (WDR) is set in this configuration to a ratio of 1:127.7 by connecting the pin to V_{DD} , the lower boundary is 19.6 ms.



(1) Use this pull-down resistor if a GPIO pin is used to drive the WDI input pin of the TPS3813 to keep the WDI pin from floating during power-up.

Figure 8. Application Example



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REVISION HISTORY

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

Changes from Revision F (August 2012) to Revision G	Page
Changed voltage from 0.6 V to 1.1 V for bottom figure	
Changes from Revision E (October 2010) to Revision F	Page
Changed from Rev E to Rev F, August 2012	1
Deleted the Pull-up resistor value row in the ROC table	3
Added Pull-up resistor value to ROC table for RESET	
Changes from Revision C (April, 2008) to Revision D	Page
Updated table pin descriptions	<u> </u>
• Changed external capacitor value recommendations in paragraph 2 of Programmable Wind	dow-Watchdog section9
Added Power-Up Considerations section	
Changed Figure 8	



10-Oct-2013

PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
TPS3813I50DBVR	ACTIVE	SOT-23	DBV	6	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	PFBI	Samples
TPS3813I50DBVRG4	ACTIVE	SOT-23	DBV	6	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	PFBI	Samples
TPS3813I50DBVT	ACTIVE	SOT-23	DBV	6	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	PFBI	Samples
TPS3813I50DBVTG4	ACTIVE	SOT-23	DBV	6	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	PFBI	Samples
TPS3813J25DBVR	ACTIVE	SOT-23	DBV	6	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	PCDI	Samples
TPS3813J25DBVRG4	ACTIVE	SOT-23	DBV	6	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	PCDI	Samples
TPS3813J25DBVT	ACTIVE	SOT-23	DBV	6	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	PCDI	Samples
TPS3813J25DBVTG4	ACTIVE	SOT-23	DBV	6	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	PCDI	Samples
TPS3813K33DBVR	ACTIVE	SOT-23	DBV	6	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	PFAI	Samples
TPS3813K33DBVRG4	ACTIVE	SOT-23	DBV	6	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	PFAI	Samples
TPS3813K33DBVT	ACTIVE	SOT-23	DBV	6	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	PFAI	Samples
TPS3813K33DBVTG4	ACTIVE	SOT-23	DBV	6	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	PFAI	Samples
TPS3813L30DBVR	ACTIVE	SOT-23	DBV	6	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	PEZI	Samples
TPS3813L30DBVRG4	ACTIVE	SOT-23	DBV	6	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	PEZI	Samples
TPS3813L30DBVT	ACTIVE	SOT-23	DBV	6	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	PEZI	Samples
TPS3813L30DBVTG4	ACTIVE	SOT-23	DBV	6	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	PEZI	Samples

⁽¹⁾ The marketing status values are defined as follows: **ACTIVE:** Product device recommended for new designs.





10-Oct-2013

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect. NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design. PREVIEW: Device has been announced but is not in production. Samples may or may not be available. OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes. **Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

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OTHER QUALIFIED VERSIONS OF TPS3813I50, TPS3813K33 :

Automotive: TPS3813I50-Q1, TPS3813K33-Q1

• Enhanced Product: TPS3813K33-EP

NOTE: Qualified Version Definitions:

• Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects



10-Oct-2013

• Enhanced Product - Supports Defense, Aerospace and Medical Applications

PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



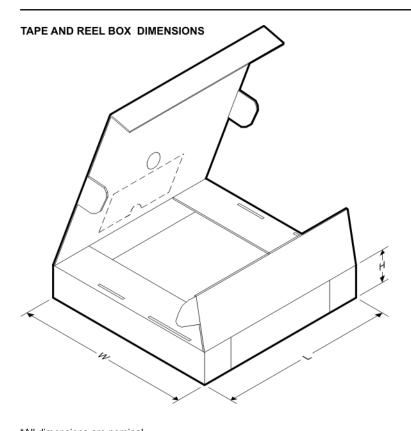
*All dimensions are nominal												
Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TPS3813I50DBVR	SOT-23	DBV	6	3000	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS3813I50DBVT	SOT-23	DBV	6	250	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS3813J25DBVR	SOT-23	DBV	6	3000	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS3813J25DBVT	SOT-23	DBV	6	250	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS3813K33DBVR	SOT-23	DBV	6	3000	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS3813K33DBVR	SOT-23	DBV	6	3000	179.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS3813K33DBVT	SOT-23	DBV	6	250	179.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS3813K33DBVT	SOT-23	DBV	6	250	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS3813L30DBVR	SOT-23	DBV	6	3000	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS3813L30DBVT	SOT-23	DBV	6	250	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3

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PACKAGE MATERIALS INFORMATION

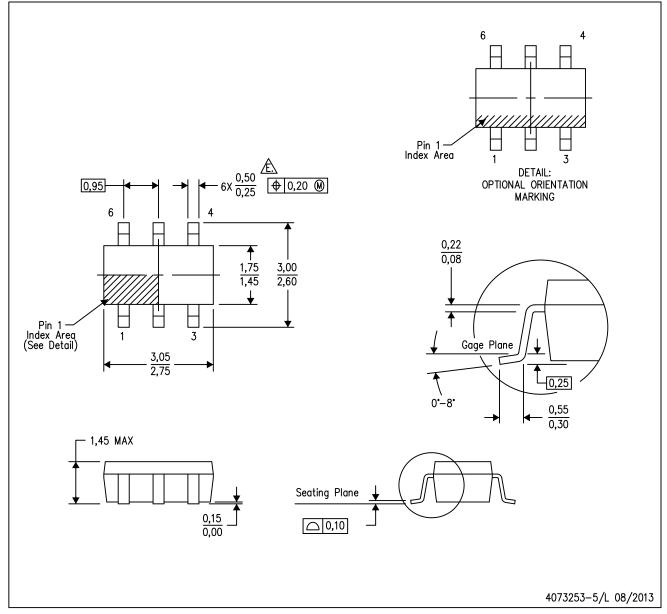
9-Oct-2013



*All dimensions are nominal							
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TPS3813I50DBVR	SOT-23	DBV	6	3000	180.0	180.0	18.0
TPS3813I50DBVT	SOT-23	DBV	6	250	180.0	180.0	18.0
TPS3813J25DBVR	SOT-23	DBV	6	3000	180.0	180.0	18.0
TPS3813J25DBVT	SOT-23	DBV	6	250	180.0	180.0	18.0
TPS3813K33DBVR	SOT-23	DBV	6	3000	180.0	180.0	18.0
TPS3813K33DBVR	SOT-23	DBV	6	3000	203.0	203.0	35.0
TPS3813K33DBVT	SOT-23	DBV	6	250	203.0	203.0	35.0
TPS3813K33DBVT	SOT-23	DBV	6	250	180.0	180.0	18.0
TPS3813L30DBVR	SOT-23	DBV	6	3000	180.0	180.0	18.0
TPS3813L30DBVT	SOT-23	DBV	6	250	180.0	180.0	18.0

DBV (R-PDSO-G6)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
 - A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
 - D. Leads 1,2,3 may be wider than leads 4,5,6 for package orientation.
 - E Falls within JEDEC MO-178 Variation AB, except minimum lead width.



LAND PATTERN DATA



NOTES:

- A. All linear dimensions are in millimeters.B. This drawing is subject to change without notice.
- C. Customers should place a note on the circuit board fabrication drawing not to alter the center solder mask defined pad.
- D. Publication IPC-7351 is recommended for alternate designs.
- E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Example stencil design based on a 50% volumetric metal load solder paste. Refer to IPC-7525 for other stencil recommendations.



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